

XXXII International Conference on Electronics, Electrical Engineering and Computing

INTERCON 2025

August 20th to 22nd, Arequipa - Peru

CALL FOR PAPERS INTERCON 2025

LAST CALL FOR PAPERS: June 15th, 2025

INTERCON (IEEE Peru Section conference) is a renowned IEEE international technical conference which has been conducted in the Peru Section, to bring exciting discoveries, knowledge & understanding together. INTERCON 2025 is the XXXII version of the conference and has been themed inspired by the IEEE Future Directions platforms. **Year 2025's INTERCON is co-organized by UCSM (Universidad Católica Santa María de Arequipa)** jointly with its IEEE UCSM Student Branch. We invite you to submit technical papers for oral presentations. INTERCON 2025 will continue the footsteps of its predecessors, to serve as a great platform for researchers to discuss and explore advanced technologies in advancing humanity.

Topics (but not limited to):

- T1. Artificial Intelligence and Machine Learning
- T2. Communications and Networking
- T3. Power, Energy, and Power Electronics
- T4. Biomedical Engineering & Healthcare Technologies
- T5. Robotics, Control, Instrumentation, and Automation
- T6. Multimedia Signal Processing and Analytics
- T7. Devices, Circuits, and Materials
- T8. Data Science and Computing Technologies
- T9. Education in Engineering and Technology
- T10. Innovation, Management, and Smart Production

Important Dates - Regular Track:

- ✓ **Deadline Paper Submission:** ~~1st Call - May 5th, 2025~~
~~2nd Call - May 31st, 2025~~
Last Call - June 15th, 2025
- ✓ **Notification of Acceptance:** ~~July 1st, 2025~~
July 7th, 2025
- ✓ **Camera Ready Submission:** July 20th, 2025
- ✓ **Author Registration:** July 20th, 2025
- ✓ **Conference Dates:** August 20th to 22nd, 2025

Submission:

The conference welcomes original **research papers written in English, with a length of 6 to 8 pages**, including the abstract and references. Papers should follow the IEEE conference template, which can be downloaded from:

- ✓ www.ieee.org/conferences/publishing/templates.html

All accepted papers require authors to sign a copyright transfer for their content. **The accepted papers will be indexed and published in the IEEE Xplore Digital Library.**

Papers must be submitted in PDF format. Submissions are to be made electronically via EasyChair:

- ✓ <https://easychair.org/conferences/?conf=intercon2025>

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